506033899 04/28/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6080614

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chun-Wei Kuo	03/24/2020

RECEIVING PARTY DATA

Name:	Realtek Semiconductor Corp.
Street Address:	2 Innovation Rd. II, Science Park
City:	HsinChu
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16860081

CORRESPONDENCE DATA

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER: REAP1023USA

NAME OF SUBMITTER: SIBYL YU

SIGNATURE: /SIBYL YU/

DATE SIGNED: 04/28/2020

Total Attachments: 2 source=3810201#page1.tif source=3810201#page2.tif

PATENT 506033899 REEL: 052507 FRAME: 0327

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

COMMUNICATION APPARATUS HAVING POWER SAVING MODE AND CAPABLE OF SAVING MORE POWER IN POWER SAVING MODE

As the below named inventor, I hereight This declaration is directed to:	by declare that:					
☑ The attached application, or						
☐ United States application nu	mber	filed on	, or			
☐ PCT international application	filed on	filed on				
The above-identified application was	made or authorized to be ma	ade by me.				
I believe that I am the original inventorapplication.	or or an original joint inventor	of a claimed invention	n in the			
I hereby acknowledge that any willful under18 U.S.C. 1001 by fine or impri	false statement made in this sonment of not more than five	declaration is punish e (5) years, or both.	able			
In consideration of the payment by	Realtek Semiconductor	Corp. having a	postal address of			
2 Innovation Rd. II, Science Park, HsinChu 30076, Taiwan, R.O.C.						
(referred to as "ASSIGNEE"below) to I of the sum of One Dollar (\$ 1.00), the receipt of which is hereby acknowledged, andfor other good and valuable consideration.						
I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.						
I hereby covenant that no assignment entered into which would conflict with	t, sale, agreement or encumb this assignment;	brance has been or w	rill be made or			
I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal						
representatives any and all papers, in maintain, issue and enforce said app equivalents thereof which may be ne IN WITNESS WHEREOF, I have her	lication, said invention and sa cessary or desirable to carry	aid Letters Patent and out the proposes ther	l said reof.			
Note: An application data sheet (PTC inventive entity, must accompany this	D/SB/14 or equivalent), includ s form, Use this form for each	ling naming the entire an additional inventor.				

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NPO#REA-P1023-USA:0 CUST#108A-129US

F#NPO-P0002E-US1201 DSB0-108U025302

Docket No REAP1023USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor:

Chun-Wei Kuo

Date:

MAR 2 4 2020

Signature:

Chun Wei Kuo

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PATENT REEL: 052507 FRAME: 0329

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RECORDED: 04/28/2020